

# WTR04P150L-HAF

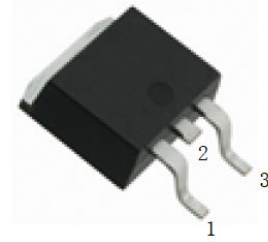
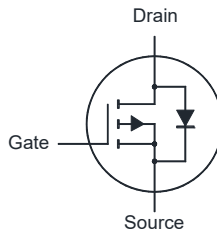
## P-Channel Enhancement Mode MOSFET

### Features

- Low  $R_{DS(ON)}$
- Low Input Capacitance
- Low Switching Charge
- Halogen and Antimony Free(-HAF), RoHS compliant

### Application

- Motor/Body Load Control
- Automotive Systems
- Load Switch
- DC-DC converters and Off-line UPS



1.Gate 2.Drain 3.Source

TO-252 Plastic Package

### Key Parameters

Parameter	Value	Unit
$-BV_{DSS}$	40	V
$R_{DS(ON)}$ Max	15 @ $-V_{GS} = 10$ V	m $\Omega$
	20 @ $-V_{GS} = 4.5$ V	
$-V_{GS(th)}$ typ	1.7	V
$Q_g$ typ	55 @ $-V_{GS} = 10$ V	nC

### Absolute Maximum Ratings (at $T_a = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$-V_{DS}$	40	V
Gate-Source Voltage	$-V_{GS}$	$\pm 20$	V
Continuous Drain Current	$-I_D$	$T_c = 25^\circ\text{C}$	43.7
		$T_c = 100^\circ\text{C}$	27.5
Peak Drain Current, Pulsed <sup>1)</sup>	$-I_{DM}$	150	A
Avalanche Current	$-I_{AS}$	37.8	A
Single Pulse Avalanche Energy <sup>2)</sup>	$E_{AS}$	71.4	mJ
Power Dissipation	$P_D$	37.4	W
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	- 55 to + 150	$^\circ\text{C}$

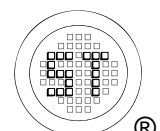
### Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Case	$R_{\theta JC}$	3.3	$^\circ\text{C/W}$
Thermal Resistance from Junction to Ambient <sup>3)</sup>	$R_{\theta JA}$	35	$^\circ\text{C/W}$

<sup>1)</sup> Pulse Test: Pulse Width  $\leq 100$   $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ , Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)} = 150^\circ\text{C}$ .

<sup>2)</sup> Limited by  $T_{J(MAX)}$ , starting  $T_J = 25^\circ\text{C}$ ,  $L = 0.1$  mH,  $R_g = 25$   $\Omega$ ,  $-I_D = 37.8$  A,  $-V_{GS} = 10$  V.

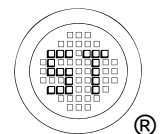
<sup>3)</sup> Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.



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Characteristics at  $T_a = 25^\circ\text{C}$  unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>					
Drain-Source Breakdown Voltage at $-I_D = 250 \mu\text{A}$	$-BV_{DSS}$	40	-	-	V
Drain-Source Leakage Current at $-V_{DS} = 32 \text{ V}$	$-I_{DSS}$	-	-	1	$\mu\text{A}$
Gate Leakage Current at $V_{GS} = \pm 20 \text{ V}$	$I_{GSS}$	-	-	$\pm 100$	nA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$ , $-I_D = 250 \mu\text{A}$	$-V_{GS(th)}$	1	-	2.5	V
Drain-Source On-State Resistance at $-V_{GS} = 10 \text{ V}$ , $-I_D = 8 \text{ A}$ at $-V_{GS} = 4.5 \text{ V}$ , $-I_D = 6 \text{ A}$	$R_{DS(on)}$	- -	11 -	15 20	$\text{m}\Omega$
<b>DYNAMIC PARAMETERS</b>					
Forward Transconductance at $-V_{DS} = 5 \text{ V}$ , $-I_D = 8 \text{ A}$	$g_{Fs}$	-	18.4	-	S
Gate resistance at $V_{DS} = 0 \text{ V}$ , $f = 1 \text{ MHz}$	$R_g$	-	3.1	-	$\Omega$
Input Capacitance at $-V_{DS} = 20 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $f = 1 \text{ MHz}$	$C_{iss}$	-	3425	-	pF
Output Capacitance at $-V_{DS} = 20 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $f = 1 \text{ MHz}$	$C_{oss}$	-	253	-	pF
Reverse Transfer Capacitance at $-V_{DS} = 20 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $f = 1 \text{ MHz}$	$C_{riss}$	-	155	-	pF
Total Gate Charge at $-V_{DS} = 20 \text{ V}$ , $-V_{GS} = 10 \text{ V}$ , $-I_D = 8 \text{ A}$ at $-V_{DS} = 20 \text{ V}$ , $-V_{GS} = 4.5 \text{ V}$ , $-I_D = 8 \text{ A}$	$Q_g$	- -	55 25	- -	nC
Gate-Source Charge at $-V_{DS} = 20 \text{ V}$ , $-V_{GS} = 10 \text{ V}$ , $-I_D = 8 \text{ A}$	$Q_{gs}$	-	12	-	nC
Gate-Drain Charge at $-V_{DS} = 20 \text{ V}$ , $-V_{GS} = 10 \text{ V}$ , $-I_D = 8 \text{ A}$	$Q_{gd}$	-	7	-	nC
Turn-On Delay Time at $-V_{DD} = 20 \text{ V}$ , $-V_{GS} = 10 \text{ V}$ , $-I_D = 8 \text{ A}$ , $R_G = 3.3 \Omega$	$t_{d(on)}$	-	21	-	nS
Turn-On Rise Time at $-V_{DD} = 20 \text{ V}$ , $-V_{GS} = 10 \text{ V}$ , $-I_D = 8 \text{ A}$ , $R_G = 3.3 \Omega$	$t_r$	-	20	-	nS
Turn-Off Delay Time at $-V_{DD} = 20 \text{ V}$ , $-V_{GS} = 10 \text{ V}$ , $-I_D = 8 \text{ A}$ , $R_G = 3.3 \Omega$	$t_{d(off)}$	-	26	-	nS
Turn-Off Fall Time at $-V_{DD} = 20 \text{ V}$ , $-V_{GS} = 10 \text{ V}$ , $-I_D = 8 \text{ A}$ , $R_G = 3.3 \Omega$	$t_f$	-	14	-	nS
<b>Body-Diode PARAMETERS</b>					
Drain-Source Diode Forward Voltage at $-I_S = 8 \text{ A}$ , $V_{GS} = 0 \text{ V}$	$-V_{SD}$	-	-	1.2	V
Body-Diode Continuous Current	$-I_S$	-	-	43.7	A
Body-Diode Continuous Current, Pulsed	$-I_{SM}$	-	-	150	A
Body Diode Reverse Recovery Time at $-I_S = 8 \text{ A}$ , $di/dt = 100 \text{ A} / \mu\text{s}$	$t_{rr}$	-	15	-	nS
Body Diode Reverse Recovery Charge at $-I_S = 8 \text{ A}$ , $di/dt = 100 \text{ A} / \mu\text{s}$	$Q_{rr}$	-	8	-	nC



## Electrical Characteristics Curves

Fig. 1 Typical Output Characteristic

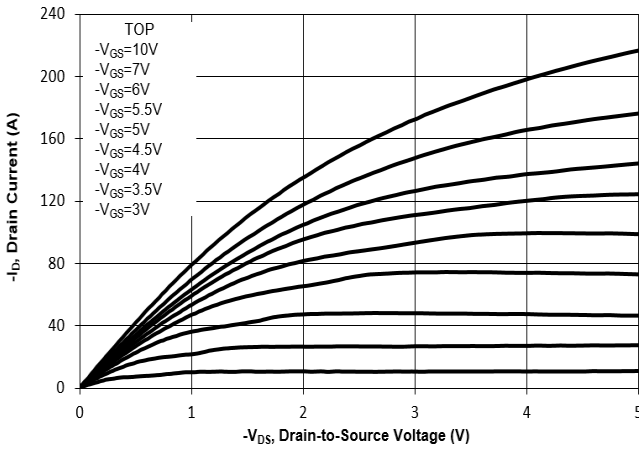


Fig. 2 Typical Transfer Characteristic

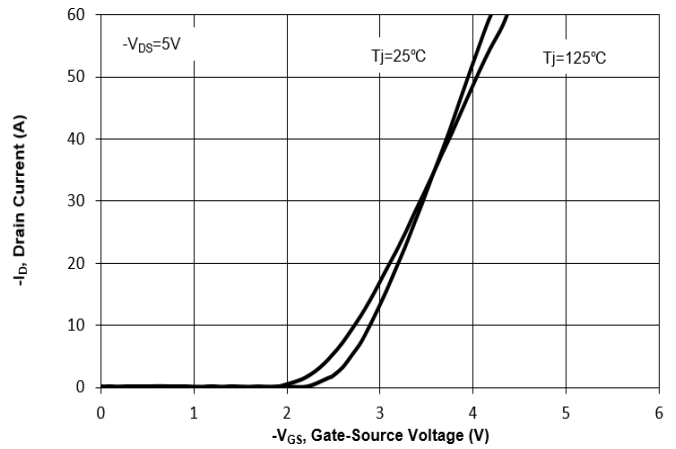


Fig. 3 On-Resistance vs. Drain Current

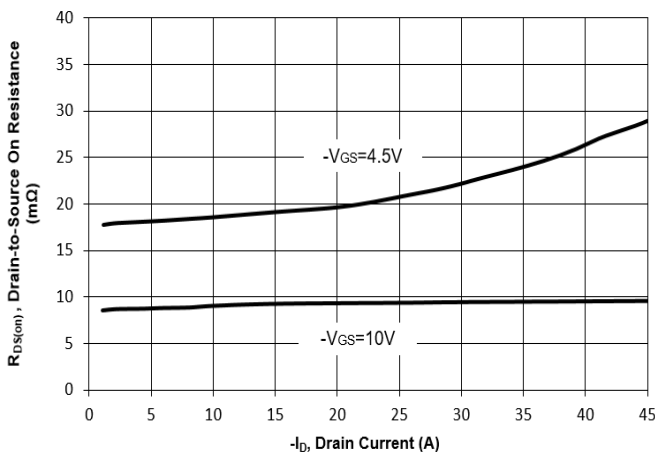


Fig. 4 On-Resistance vs. Gate Voltage

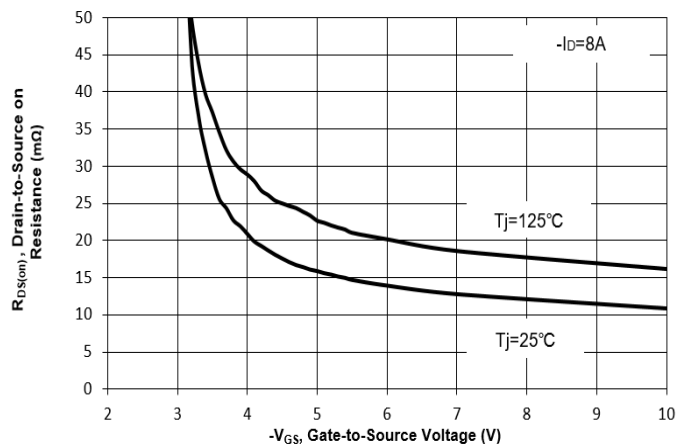


Fig. 5 On-Resistance vs. Tj

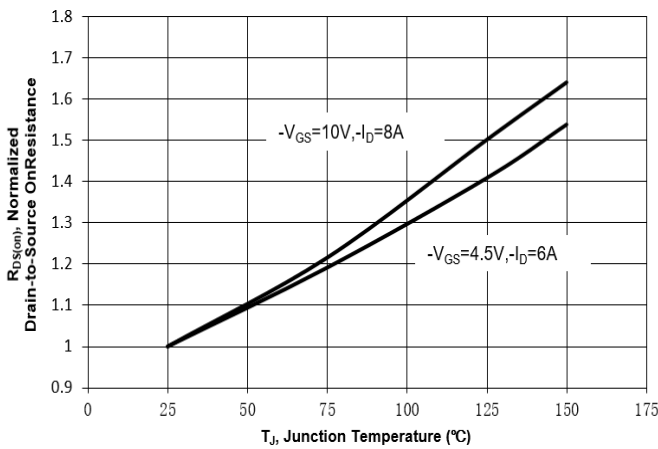
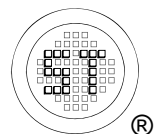
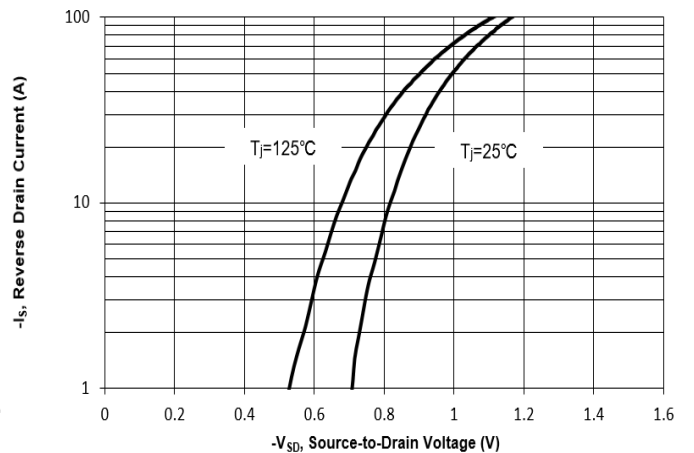


Fig. 6 Typical Body-Diode Forward Characteristic



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## Electrical Characteristics Curves

Fig. 7 Typical Junction Capacitance

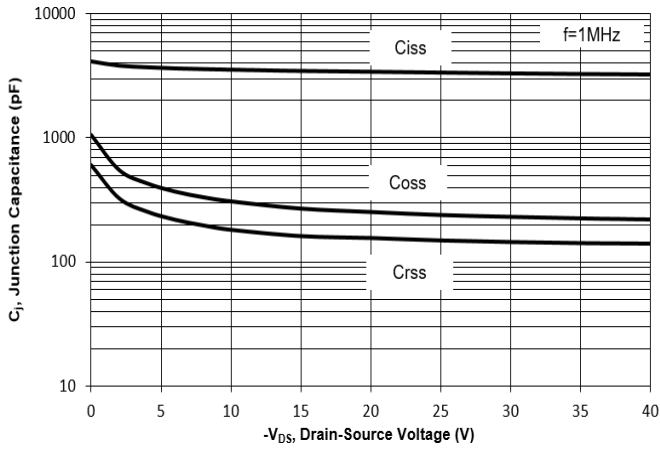


Fig. 8 Drain-Source Leakage Current vs. Tj

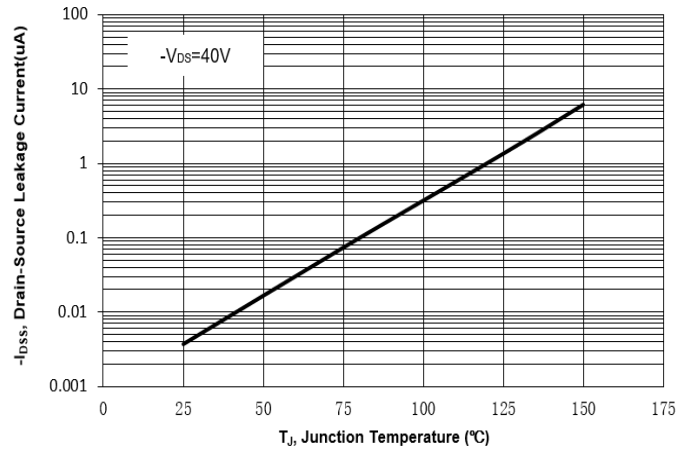


Fig. 9 V(BR)DSS vs. Junction Temperature

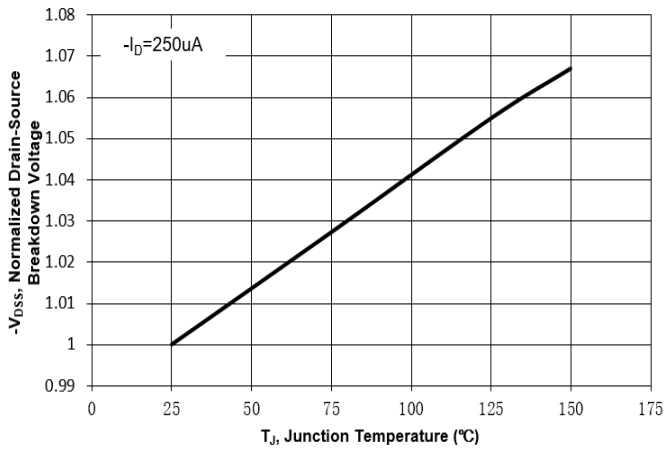


Fig. 10 Gate Threshold Variation vs. Tj

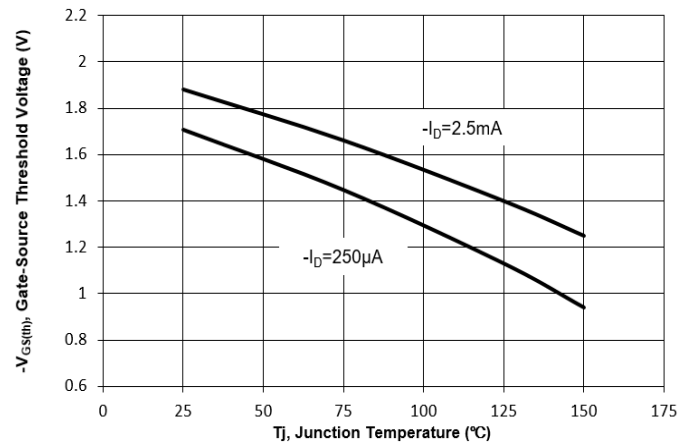


Fig. 11 Gate Charge

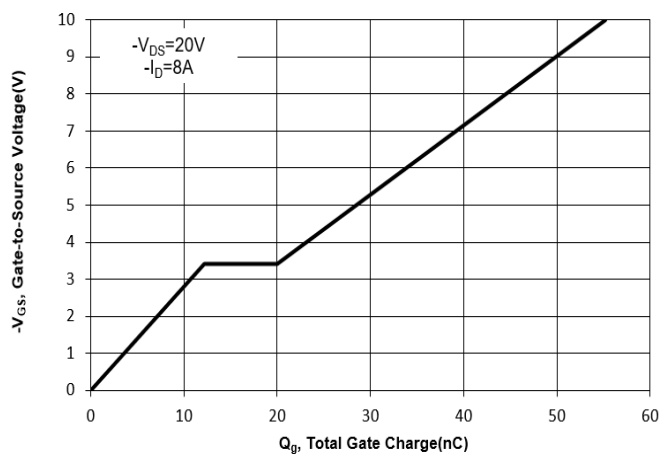
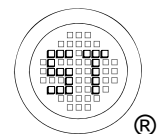
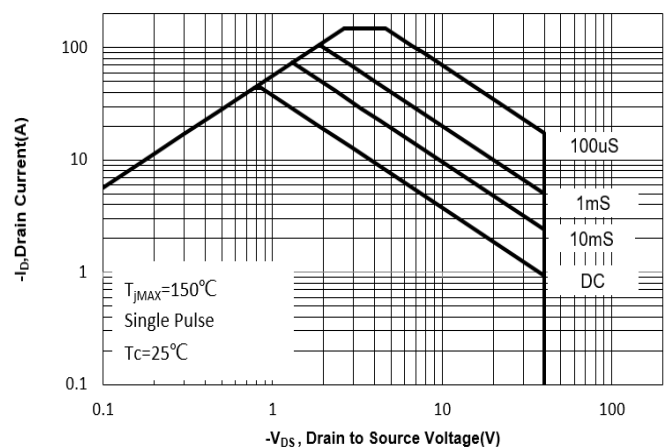


Fig. 12 Safe Operation Area



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## Electrical Characteristics Curves

Fig.13 Normalized Maximum Transient Thermal Impedance( $Z_{\theta JC}$ )

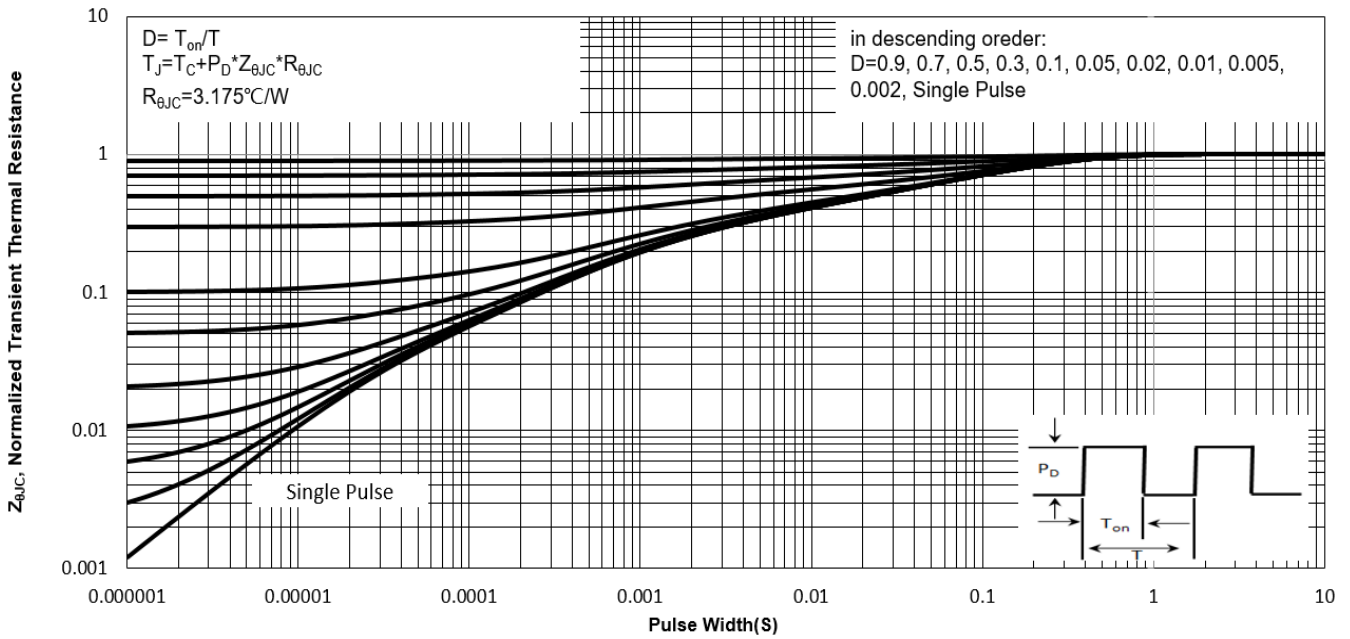
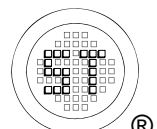
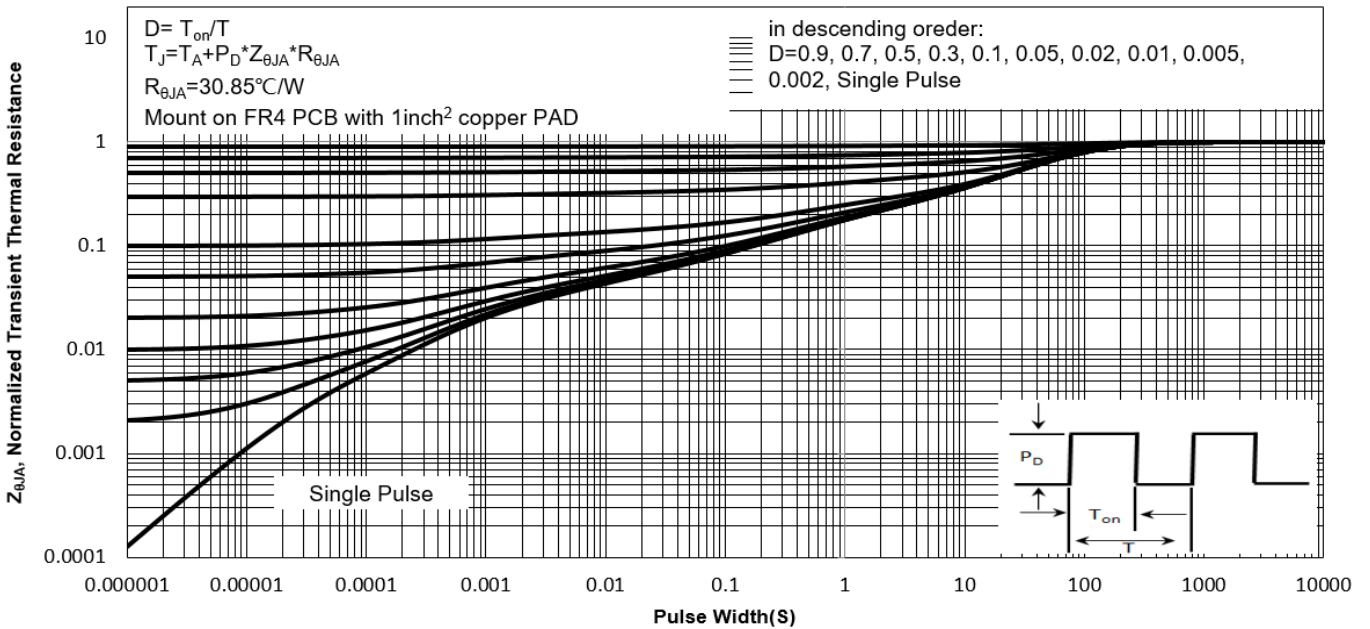


Fig.14 Normalized Maximum Transient Thermal Impedance( $Z_{\theta JA}$ )



## Test Circuits

Fig.1-1 Switching times test circuit

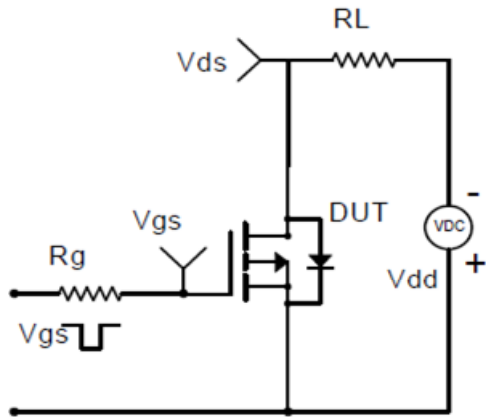


Fig.1-2 Switching Waveform

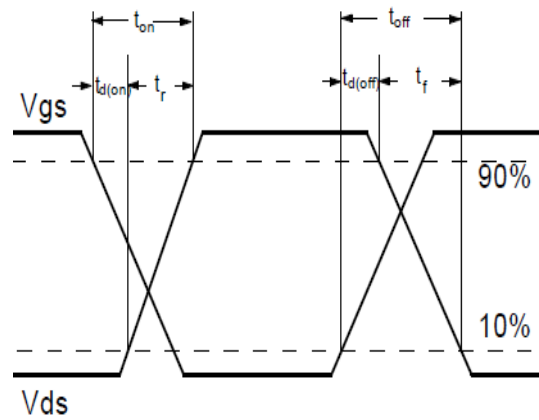


Fig.2-1 Gate charge test circuit

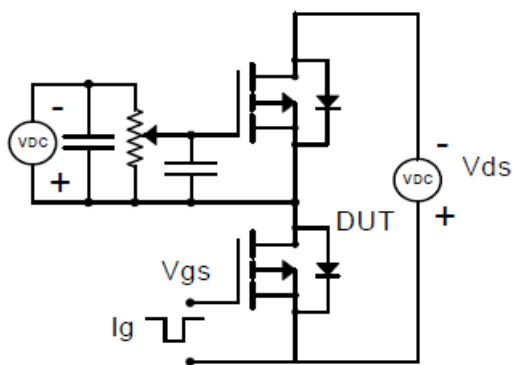


Fig.2-2 Gate charge waveform

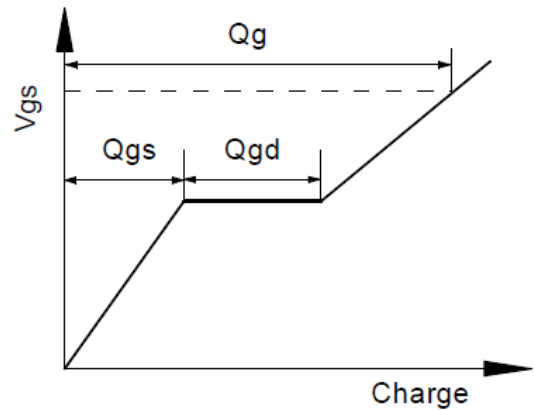


Fig.3-1 Avalanche test circuit

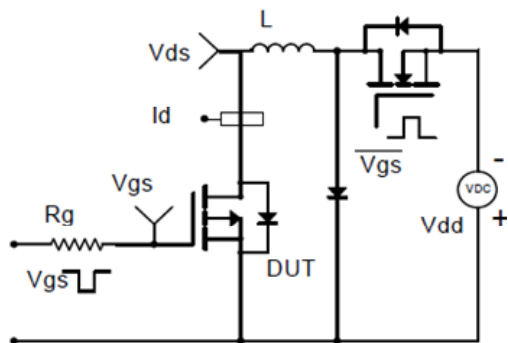
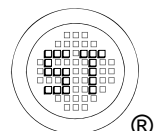
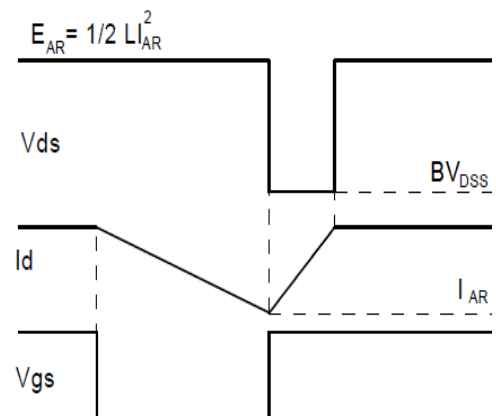


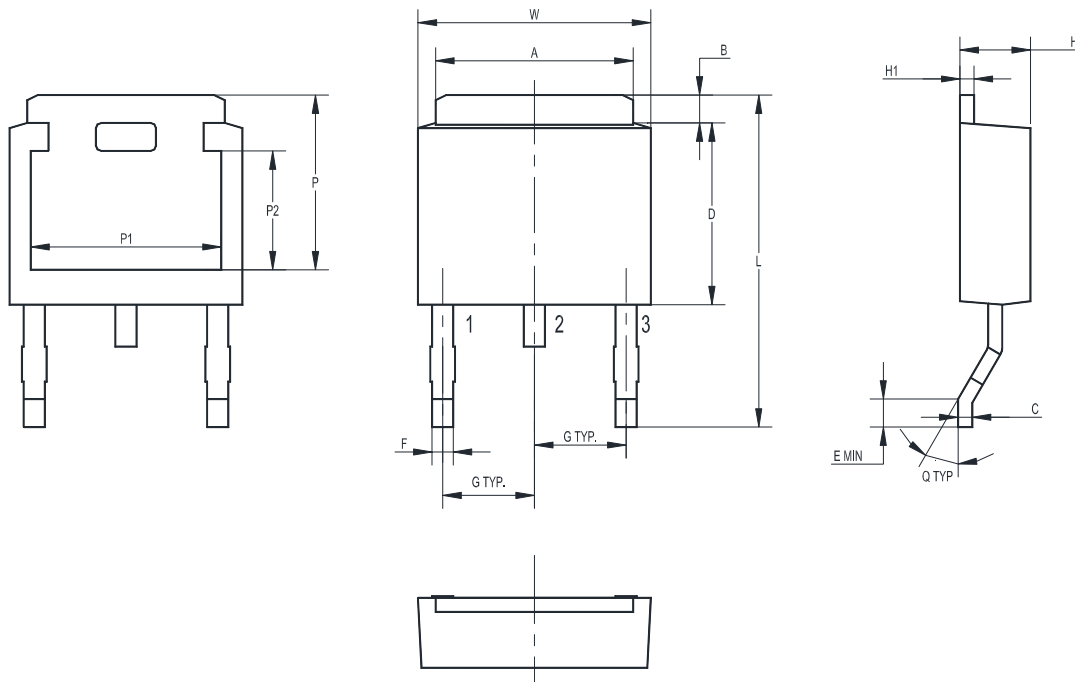
Fig.3-2 Avalanche waveform



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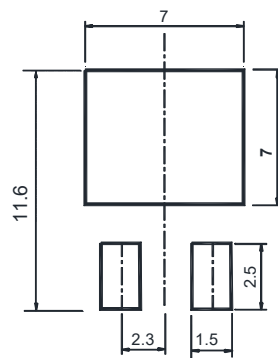
## Package Outline (Dimensions in mm)

TO-252



UNIT	A	B	C	D	E	F	G	W	H	H1	Q	L	P	P1	P2
mm	5.5	1.20	0.65	6.2	0.8	1.0	2.3	6.7	2.5	0.65	60°	10.7	5.4	5.0	3.4
	4.9	0.85	0.4	5.6	MIN	0.5	TYP	6.1	2.1	0.4	TYP	9	5.0	4.6	2.9

## Recommended Soldering Footprint



## Packing information

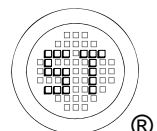
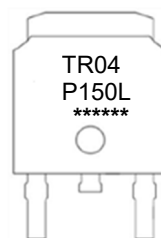
Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
TO-252	12	8 ± 0.1	0.315 ± 0.004	330	13	2,500

## Marking information

" TR04P150L " = Part No.

" \*\*\*\*\* " = Date Code Marking

Font type: Arial



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